

MOS FIELD EFFECT TRANSISTOR

NP80N055CLE,NP80N055DLE,NP80N055ELE,NP80N055KLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

RDS(on)1 = 11 m Ω MAX. (VGS = 10 V, ID = 40 A) RDS(on)2 = 13 m Ω MAX. (VGS = 5 V, ID = 40 A)

• Low Ciss: Ciss = 2900 pF TYP.

• Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP80N055CLE	TO-220AB
NP80N055DLE	TO-262
NP80N055ELE	TO-263 (MP-25ZJ)
NP80N055KLE	TO-263 (MP-25ZK)

(TO-220AB)



(TO-262)



(TO-263)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	•	•	
Drain to Source Voltage (Vgs = 0 V)	VDSS	55	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C) ^{Note1}	ID(DC)	±80	Α
Drain Current (Pulse) Note2	ID(pulse)	±200	Α
Total Power Dissipation (Tc = 25°C)	Рт	120	W
Total Power Dissipation (T _A = 25°C)	Рт	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note3	las	45 / 30 / 10	Α
Single Avalanche Energy Note3	Eas	2.0 / 90 / 100	mJ

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

- **2.** PW \leq 10 μ s, Duty cycle \leq 1%
- 3. Starting T_{ch} = 25°C, V_{DD} = 28 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see Figure 4.)

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THERMAL RESISTANCE

Channel to Case Thermal Resistance $R_{th(ch-C)}$ 1.25 °C/W Channel to Ambient Thermal Resistance $R_{th(ch-A)}$ 83.3 °C/W

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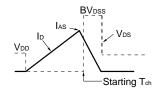
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ELECTRICAL CHARACTERISTICS (TA = 25°C)

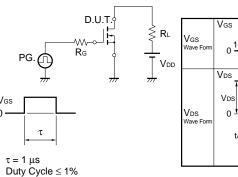
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 55 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 40 A	15	40		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 40 A		8.4	11	mΩ
	R _{DS(on)2}	Vgs = 5 V, ID = 40 A		10.3	13	mΩ
	R _{DS(on)3}	Vgs = 4.5 V, ID = 40 A		11.3	15	mΩ
Input Capacitance	Ciss	Vps = 25 V		2900	4400	pF
Output Capacitance	Coss	Vgs = 0 V		380	570	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		170	310	pF
Turn-on Delay Time	t _{d(on)}	VDD = 28 V, ID = 40 A		22	48	ns
Rise Time	tr	Vgs = 10 V		10	25	ns
Turn-off Delay Time	t _{d(off)}	$R_G = 1 \Omega$		62	120	ns
Fall Time	tf			11	27	ns
Total Gate Charge 1	Q _{G1}	V _{DD} = 44 V, V _{GS} = 10 V, I _D = 80 A		50	75	nC
Total Gate Charge 2	Q _{G2}	VDD = 44 V		26	39	nC
Gate to Source Charge	Qgs	Vgs = 5 V		12		nC
Gate to Drain Charge	Q _{GD}	ID = 80 A		15		nC
Body Diode Forward Voltage	V _F (S-D)	IF = 80 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 80 A, VGS = 0 V		50		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		100		nC

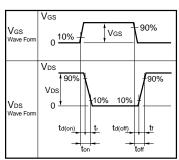
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$



TEST CIRCUIT 2 SWITCHING TIME





TEST CIRCUIT 3 GATE CHARGE

20

0

0

25 50 75 100 125 150 175 200

TYPICAL CHARACTERISTICS (TA = 25°C)

Figure 1. DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

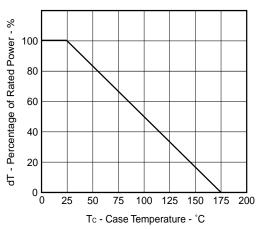


Figure 3. FORWARD BIAS SAFE OPERATING AREA

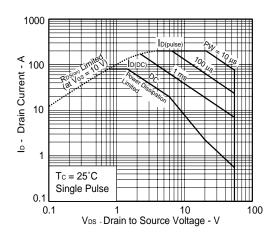
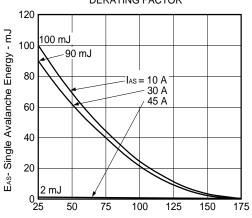


Figure 2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE 140 ≥ 120 P⊤ - Total Power Dissipation -100 80 60 40

Figure4. SINGLE AVALANCHE ENERGY DERATING FACTOR

Tc - Case Temperature - °C



Starting Tch - Starting Channel Temperature - °C

Figure 5. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

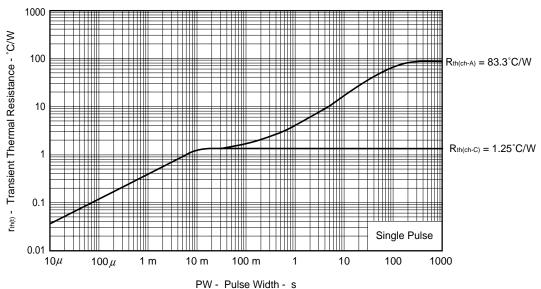


Figure 6. FORWARD TRANSFER CHARACTERISTICS

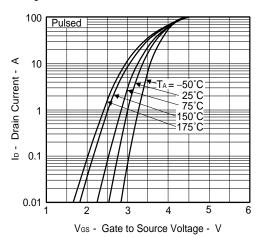


Figure 8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

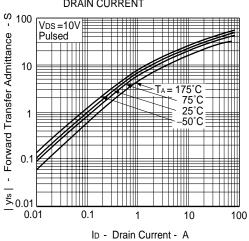
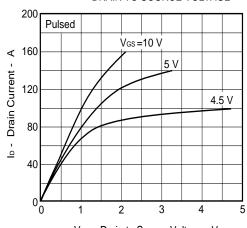


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT Drain to Source On-state Resistance - $m\Omega$ Pulsed 30 $V_{GS} = 4.5 \text{ V}$ 20 5 V -10 V 10 0 100 1000 Ip - Drain Current - A

Figure7. DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



VDS - Drain to Source Voltage - V

Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

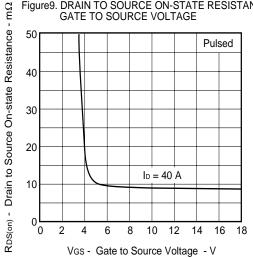
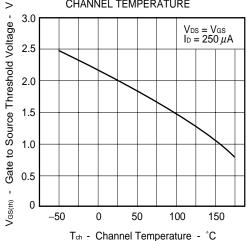
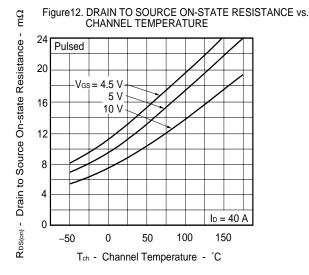
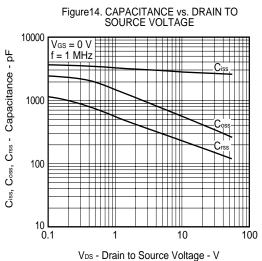


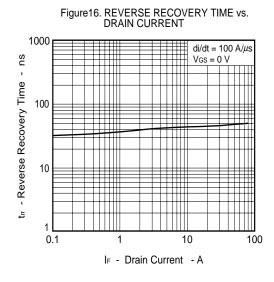
Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

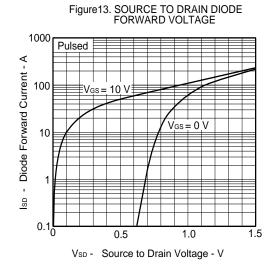


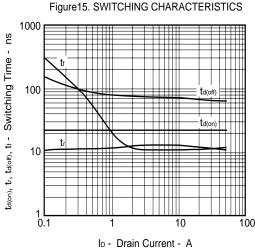
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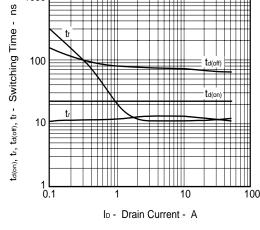


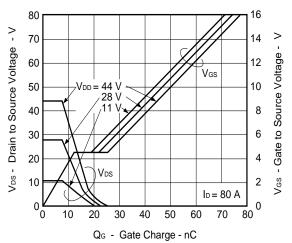






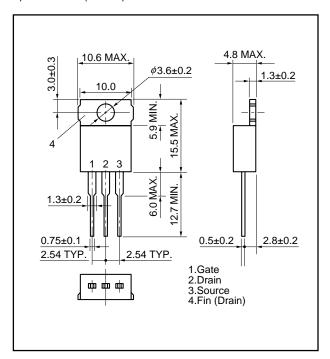




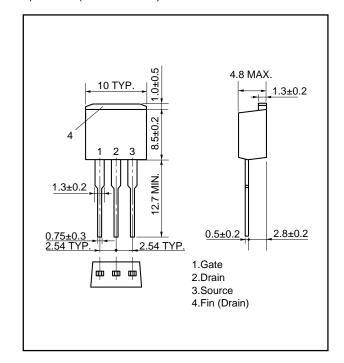


PACKAGE DRAWINGS (Unit: mm)

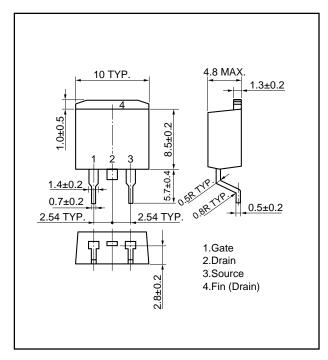
1) TO-220AB (MP-25)



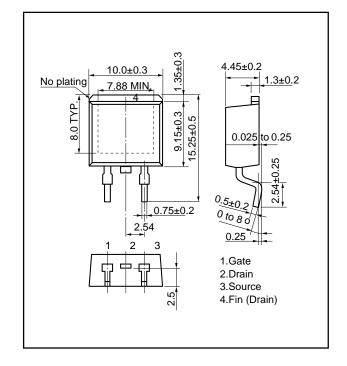
2) TO-262 (MP-25 Fin Cut)



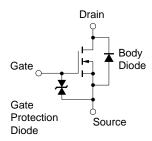
3) TO-263 (MP-25ZJ)



★ 4) TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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